

## **Quarterly Reliability Monitoring Results**

## Quarters: Q1/2021 to Q4/2021

Based on structural similarity

| Supplier Nexperia B.V.    |                             | User Part Number  |                |               |            |           |  |  |
|---------------------------|-----------------------------|---|----------------|---------------|------------|-----------|--|--|
|                           |                             | BAS21LD   |                |               |            |           |  |  |
| Name of Laboratory        |                             | Part Description  |                |               |            |           |  |  |
|                           |                             | Nexperia DHAM   | Small Signal E | Bipolar Diode |            |           |  |  |
| Assembly reliability labs |                             | MCD package   |                |               |            |           |  |  |
| Based on AEC-Q101 Test    |                             | Test Conditions   | Duration       | # Lots        | # Quantity | # Rejects |  |  |
|                           | TEST                        |   |                |               |            |           |  |  |
|                           | Pre- and Post-Stress        |   |                |               |            |           |  |  |
| # E1                      | Electrical Test             | Tamb = 25 °C  | N/A            | see below     | all parts  | see below |  |  |
|                           |                             | JESD22-A113   |                |               |            |           |  |  |
|                           |                             | Bake Tamb = 125 °C  | 24 hours       |               |            |           |  |  |
|                           | PC<br>Decembricaning        | Soak Tamb = 85 °C, RH = 85%   | 168 hours      |               |            | _         |  |  |
| # A1                      | Preconditioning             | Reflow soldering  | 3 cycles       | 113           | 9040       | 0         |  |  |
|                           |                             | MIL-STD-750-1   |                |               |            |           |  |  |
|                           | HTRB                        | M1038 Method A  |                |               |            |           |  |  |
|                           |                             | Tj = Tjmax, Vr = 100% of max. datasheet   |                |               |            | _         |  |  |
| # B1                      | Bias                        | reverse voltage   | 1000 hours     | 67            | 5360       | 0         |  |  |
|                           | тс                          | JECD22 A104   |                |               |            |           |  |  |
|                           | Temperature Cycling         | JESD22-A104<br>-65 °C to Timax, not to exceed 150°C                             | 1000           | 20            | 2240       | 0         |  |  |
| # A4                      | remperature cycling         | ,   | 1000 cycles    | 28            | 2240       | 0         |  |  |
|                           | AC                          | JESD22-A102<br>Tamb = 121 °C, RH = 100 %  |                |               |            |           |  |  |
| # A3 alt                  | AC<br>Autoclave             | Pressure = 205 kPa (29.7 psia)  | 96 hours       | 20            | 2240       | 0         |  |  |
| # A3 ait                  | Autociave                   | riessuie – 203 kra (23.7 psia)  | 96 nours       | 28            | 2240       | 0         |  |  |
|                           | H3TRB                       | JESD22-A101   |                |               |            |           |  |  |
|                           | High Humidity High          | Tamb = 85 °C, RH = 85%, VR = 80 % of  |                |               |            |           |  |  |
| # A2 alt                  | Temperature Reverse Bias    |   | 1000 hours     | 28            | 2240       | 0         |  |  |
| # AZ dit                  | Temperature Neverse Blas    |   | 1000 110015    | 20            | 2240       | U         |  |  |
|                           | IOL                         | MIL-STD-750 Method 1037<br>ton = toff, devices powered to insure $\Delta T_j =$ |                |               |            |           |  |  |
| # A5                      | Intermittent Operating Life |   | 1000 hours     | 29            | 2320       | 0         |  |  |
| # A3                      | Intermittent Operating Life | 100 0 101 15000 070105  | 1000 Hours     | 23            | 2320       | U         |  |  |
|                           | RSH                         | JESD22-A111   |                |               |            |           |  |  |
| # C8                      | Resistance to Solder Heat   | 260 °C ± 5 °C   | 10 s           | n.a.          | n.a.       | n.a.      |  |  |
| # 00                      | SD                          |   | 10.5           | II.a.         | II.a.      | 11.0.     |  |  |
| # C10                     | Solderability               | J-STD-002   |                | 63            | 630        | 0         |  |  |
| # C10                     | Soluerability               | J-21D-005   |                | 63            | 630        | 0         |  |  |

<sup>[1]</sup> The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

## **Calculation of FIT and MTTF**

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1)
Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

| Wafer Fab | Technology                 | Quantity | Rejects | Failure Rate (FIT) | MTTF (hrs) |
|-----------|----------------------------|----------|---------|--------------------|------------|
| Nexperia  |                            |          |         |                    |            |
| DHAM      | Small Signal Bipolar Diode | 5360     | 0       | 0.79               | 1.26E+09   |

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